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Understanding Embedded - FPGAs (Field Programmable Gate Array)

Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

Applications of Embedded - FPGAs

The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications.

Details

Product Status	Obsolete
Number of LABs/CLBs	600
Number of Logic Elements/Cells	2700
Total RAM Bits	40960
Number of I/O	102
Number of Gates	100000
Voltage - Supply	1.71V ~ 1.89V
Mounting Type	Surface Mount
Operating Temperature	0°C ~ 85°C (TJ)
Package / Case	144-LQFP
Supplier Device Package	144-TQFP (20x20)
Purchase URL	https://www.e-xfl.com/product-detail/xilinx/xc2s100e-6tqg144c



Spartan-IIE FPGA Family: Introduction and Ordering Information

DS077-1 (v3.0) August 9, 2013

Product Specification

Introduction

The Spartan®-IIE Field-Programmable Gate Array family gives users high performance, abundant logic resources, and a rich feature set, all at an exceptionally low price. The seven-member family offers densities ranging from 50,000 to 600,000 system gates, as shown in [Table 1](#). System performance is supported beyond 200 MHz.

Features include block RAM (to 288K bits), distributed RAM (to 221,184 bits), 19 selectable I/O standards, and four DLLs (Delay-Locked Loops). Fast, predictable interconnect means that successive design iterations continue to meet timing requirements.

The Spartan-IIE family is a superior alternative to mask-programmed ASICs. The FPGA avoids the initial cost, lengthy development cycles, and inherent risk of conventional ASICs. Also, FPGA programmability permits design upgrades in the field with no hardware replacement necessary (impossible with ASICs).

Features

- Second generation ASIC replacement technology
 - Densities as high as 15,552 logic cells with up to 600,000 system gates
 - Streamlined features based on Virtex®-E FPGA architecture
 - Unlimited in-system reprogrammability
 - Very low cost
 - Cost-effective 0.15 micron technology
- System level features
 - SelectRAM™ hierarchical memory:
 - 16 bits/LUT distributed RAM
 - Configurable 4K-bit true dual-port block RAM

- Fast interfaces to external RAM
- Fully 3.3V PCI compliant to 64 bits at 66 MHz and CardBus compliant
- Low-power segmented routing architecture
- Dedicated carry logic for high-speed arithmetic
- Efficient multiplier support
- Cascade chain for wide-input functions
- Abundant registers/latches with enable, set, reset
- Four dedicated DLLs for advanced clock control
 - Eliminate clock distribution delay
 - Multiply, divide, or phase shift
- Four primary low-skew global clock distribution nets
- IEEE 1149.1 compatible boundary scan logic
- Versatile I/O and packaging
 - Pb-free package options
 - Low-cost packages available in all densities
 - Family footprint compatibility in common packages
 - 19 high-performance interface standards
 - LVTTTL, LVCMOS, HSTL, SSTL, AGP, CTT, GTL
 - LVDS and LVPECL differential I/O
 - Up to 205 differential I/O pairs that can be input, output, or bidirectional
 - Hot swap I/O (CompactPCI friendly)
- Core logic powered at 1.8V and I/Os powered at 1.5V, 2.5V, or 3.3V
- Fully supported by powerful Xilinx® ISE® development system
 - Fully automatic mapping, placement, and routing
 - Integrated with design entry and verification tools
 - Extensive IP library including DSP functions and soft processors

Table 1: Spartan-IIE FPGA Family Members

Device	Logic Cells	Typical System Gate Range (Logic and RAM)	CLB Array (R x C)	Total CLBs	Maximum Available User I/O ⁽¹⁾	Maximum Differential I/O Pairs	Distributed RAM Bits	Block RAM Bits
XC2S50E	1,728	23,000 - 50,000	16 x 24	384	182	83	24,576	32K
XC2S100E	2,700	37,000 - 100,000	20 x 30	600	202	86	38,400	40K
XC2S150E	3,888	52,000 - 150,000	24 x 36	864	265	114	55,296	48K
XC2S200E	5,292	71,000 - 200,000	28 x 42	1,176	289	120	75,264	56K
XC2S300E	6,912	93,000 - 300,000	32 x 48	1,536	329	120	98,304	64K
XC2S400E	10,800	145,000 - 400,000	40 x 60	2,400	410	172	153,600	160K
XC2S600E	15,552	210,000 - 600,000	48 x 72	3,456	514	205	221,184	288K

Notes:

1. User I/O counts include the four global clock/user input pins. See details in [Table 2, page 5](#)

Spartan-IIE Product Availability

Table 2 shows the maximum user I/Os available on the device and the number of user I/Os available for each device/package combination.

Table 2: Spartan-IIE FPGA User I/O Chart

Device	Maximum User I/O	Available User I/O According to Package Type				
		TQ144 TQG144	PQ208 PQG208	FT256 FTG256	FG456 FGG456	FG676 FGG676
XC2S50E	182	102	146	182	-	-
XC2S100E	202	102	146	182	202	-
XC2S150E	265	-	146	182	265	-
XC2S200E	289	-	146	182	289	-
XC2S300E	329	-	146	182	329	-
XC2S400E	410	-	-	182	329	410
XC2S600E	514	-	-	-	329	514

Notes:

1. User I/O counts include the four global clock/user input pins.

Table 8: Boundary-Scan Instructions (Continued)

Boundary-Scan Command	Binary Code[4:0]	Description
INTEST	00111	Enables boundary-scan INTEST operation
USERCODE	01000	Enables shifting out USER code
IDCODE	01001	Enables shifting out of ID Code
HIGHZ	01010	Disables output pins while enabling the Bypass Register
JSTART	01100	Clock the start-up sequence when StartupClk is TCK
BYPASS	11111	Enables BYPASS
RESERVED	All other codes	Xilinx reserved instructions

The public boundary-scan instructions are available prior to configuration, except for USER1 and USER2. After configuration, the public instructions remain available together with any USERCODE instructions installed during the configuration. While the SAMPLE/PRELOAD and BYPASS instructions are available during configuration, it is recommended that boundary-scan operations not be performed during this transitional period.

In addition to the test instructions outlined above, the boundary-scan circuitry can be used to configure the FPGA, and also to read back the configuration data.

To facilitate internal scan chains, the User Register provides three outputs (Reset, Update, and Shift) that represent the corresponding states in the boundary-scan internal state machine.

Figure 14 is a diagram of the Spartan-IIE family boundary scan logic. It includes three bits of Data Register per IOB, the IEEE 1149.1 Test Access Port controller, and the Instruction Register with decodes.

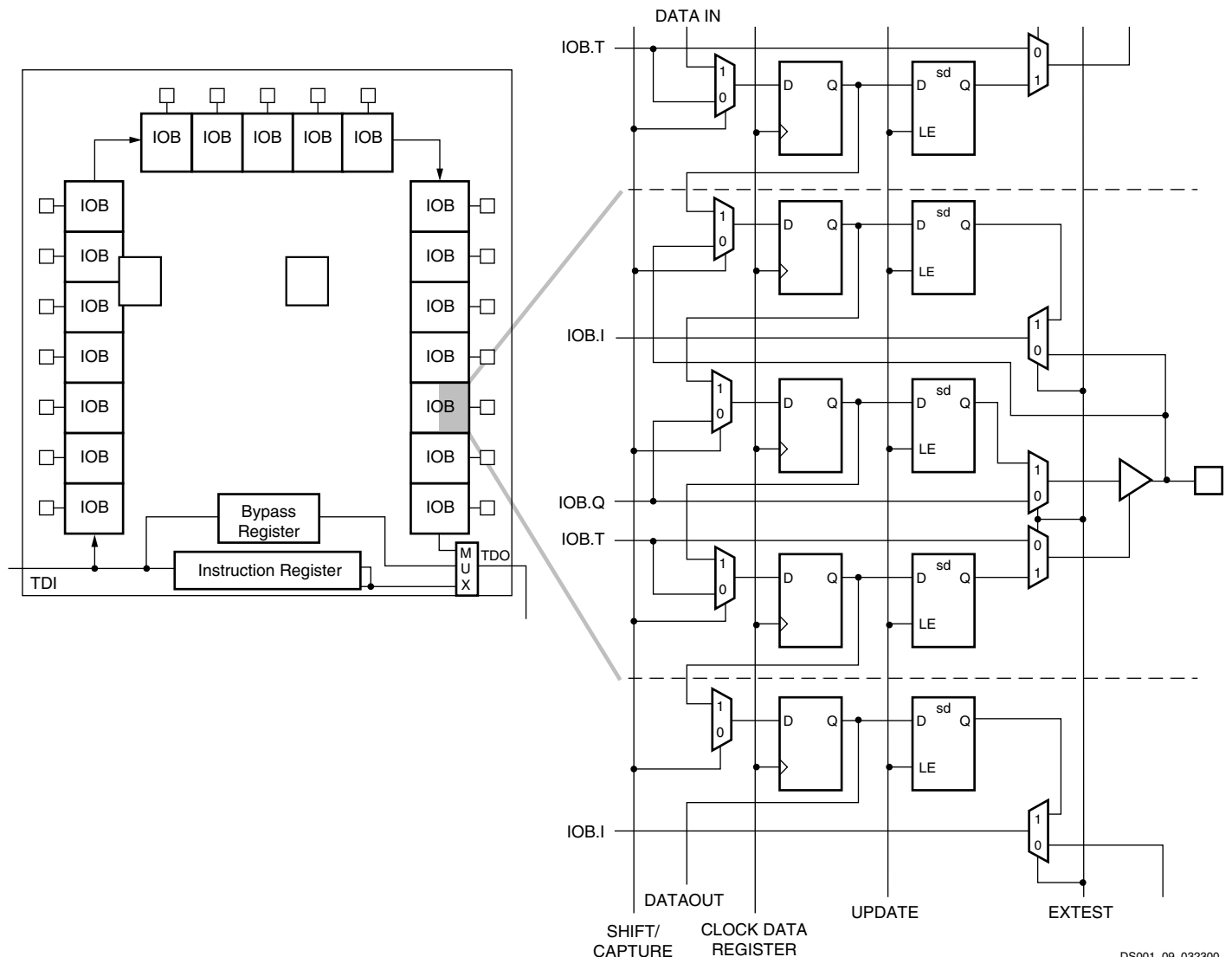


Figure 14: Spartan-IIE Family Boundary Scan Logic

Switching Characteristics

Internal timing parameters are derived from measuring internal test patterns. Listed below are representative values. For more specific, more precise, and worst-case guaranteed data, use the values reported by the static timing analyzer (TRACE in the Xilinx Development System) and

back-annotated to the simulation netlist. All timing parameters assume worst-case operating conditions (supply voltage and junction temperature). Values apply to all Spartan-IIIE devices unless otherwise noted.

Global Clock Input to Output Delay for LVTTL, *with* DLL (Pin-to-Pin)⁽¹⁾

Symbol	Description	Speed Grade			Units
		All	-7	-6	
		Min	Max	Max	
$T_{ICKOFDLL}$	LVTTL global clock input to output delay using output flip-flop for LVTTL, 12 mA, fast slew rate, <i>with</i> DLL.	1.0	3.1	3.1	ns

Notes:

1. Listed above are representative values where one global clock input drives one vertical clock line in each accessible column, and where all accessible IOB and CLB flip-flops are clocked by the global clock net.
2. Output timing is measured at 1.4V with 35 pF external capacitive load for LVTTL. The 35 pF load does not apply to the Min values. For other I/O standards and different loads, see the tables [Constants for Calculating \$T_{IOOP}\$](#) and [Delay Measurement Methodology](#), page 41.
3. DLL output jitter is already included in the timing calculation.
4. For data *output* with different standards, adjust delays with the values shown in [IOB Output Delay Adjustments for Different Standards\(1\)](#), page 40. For a global clock input with standards other than LVTTL, adjust delays with values from the [I/O Standard Global Clock Input Adjustments](#), page 42.

Global Clock Input to Output Delay for LVTTL, *without* DLL (Pin-to-Pin)⁽¹⁾

Symbol	Description	Device	Speed Grade			Units
			All	-7	-6	
			Min	Max	Max	
T_{ICKOF}	LVTTL global clock input to output delay using output flip-flop for LVTTL, 12 mA, fast slew rate, <i>without</i> DLL.	XC2S50E	1.5	4.4	4.6	ns
		XC2S100E	1.5	4.4	4.6	ns
		XC2S150E	1.5	4.5	4.7	ns
		XC2S200E	1.5	4.5	4.7	ns
		XC2S300E	1.5	4.5	4.7	ns
		XC2S400E	1.5	4.6	4.8	ns
		XC2S600E	1.6	4.7	4.9	ns

Notes:

1. Listed above are representative values where one global clock input drives one vertical clock line in each accessible column, and where all accessible IOB and CLB flip-flops are clocked by the global clock net.
2. Output timing is measured at 1.4V with 35 pF external capacitive load for LVTTL. The 35 pF load does not apply to the Min values. For other I/O standards and different loads, see the tables [Constants for Calculating \$T_{IOOP}\$](#) and [Delay Measurement Methodology](#), page 41.
3. For data *output* with different standards, adjust delays with the values shown in [IOB Output Delay Adjustments for Different Standards\(1\)](#), page 40. For a global clock input with standards other than LVTTL, adjust delays with values from the [I/O Standard Global Clock Input Adjustments](#), page 42.

CLB Switching Characteristics

Delays originating at F/G inputs vary slightly according to the input used. The values listed below are worst-case. Precise values are provided by the timing analyzer.

Symbol	Description	Speed Grade				Units
		-7		-6		
		Min	Max	Min	Max	
Combinatorial Delays						
T _{ILO}	4-input function: F/G inputs to X/Y outputs	0.18	0.42	0.18	0.47	ns
T _{IF5}	5-input function: F/G inputs to F5 output	0.3	0.8	0.3	0.9	ns
T _{IF5X}	5-input function: F/G inputs to X output	0.3	0.8	0.3	0.9	ns
T _{IF6Y}	6-input function: F/G inputs to Y output via F6 MUX	0.3	0.9	0.3	1.0	ns
T _{F5INY}	6-input function: F5IN input to Y output	0.04	0.2	0.04	0.22	ns
T _{IFNCTL}	Incremental delay routing through transparent latch to XQ/YQ outputs	-	0.7	-	0.8	ns
T _{BYYB}	BY input to YB output	0.18	0.46	0.18	0.51	ns
Sequential Delays						
T _{CKO}	FF clock CLK to XQ/YQ outputs	0.3	0.9	0.3	1.0	ns
T _{CKLO}	Latch clock CLK to XQ/YQ outputs	0.3	0.9	0.3	1.0	ns
Setup/Hold Times with Respect to Clock CLK						
T _{ICK} / T _{CKI}	4-input function: F/G inputs	1.0 / 0	-	1.1 / 0	-	ns
T _{IF5CK} / T _{CKIF5}	5-input function: F/G inputs	1.4 / 0	-	1.5 / 0	-	ns
T _{F5INCK} / T _{CKF5IN}	6-input function: F5IN input	0.8 / 0	-	0.8 / 0	-	ns
T _{IF6CK} / T _{CKIF6}	6-input function: F/G inputs via F6 MUX	1.5 / 0	-	1.6 / 0	-	ns
T _{DICK} / T _{CKDI}	BX/BY inputs	0.7 / 0	-	0.8 / 0	-	ns
T _{CECK} / T _{CKCE}	CE input	0.7 / 0	-	0.7 / 0	-	ns
T _{RCK} / T _{CKR}	SR/BY inputs (synchronous)	0.52 / 0	-	0.6 / 0	-	ns
Clock CLK						
T _{CH}	Pulse width, High	1.3	-	1.4	-	ns
T _{CL}	Pulse width, Low	1.3	-	1.4	-	ns
Set/Reset						
T _{RPW}	Pulse width, SR/BY inputs	2.1	-	2.4	-	ns
T _{RQ}	Delay from SR/BY inputs to XQ/YQ outputs (asynchronous)	0.3	0.9	0.3	1.0	ns
F _{TOG}	Toggle frequency (for export control)	-	400	-	357	MHz



Spartan-IIE FPGA Family: Pinout Tables

DS077-4 (v3.0) August 9, 2013

Product Specification

Introduction

This section describes how the various pins on a Spartan®-IIE FPGA connect within the supported component packages, and provides device-specific thermal characteristics. Spartan-IIE FPGAs are available in both standard and Pb-free, RoHS versions of each package, with the Pb-free version adding a “G” to the middle of the package code. Except for the thermal characteristics, all information for the standard package applies equally to the Pb-free package.

Pin Types

Most pins on a Spartan-IIE FPGA are general-purpose, user-defined I/O pins. There are, however, different functional types of pins on Spartan-IIE FPGA packages, as outlined below.

Pin Definitions

Pad Name	Dedicated Pin	Direction	Description
GCK0, GCK1, GCK2, GCK3	No	Input	Clock input pins that connect to Global Clock buffers or DLL inputs. These pins become user inputs when not needed for clocks.
DLL	No	Input	Clock input pins that connect to DLL input or feedback clocks. Differential clock input (N input of pair) when paired with adjacent GCK input. Becomes a user I/O when not needed for clocks.
M0, M1, M2	Yes	Input	Mode pins used to specify the configuration mode.
CCLK	Yes	Input or Output	The configuration Clock I/O pin. It is an input for Slave Parallel and Slave Serial modes, and output in Master Serial mode. After configuration, it is an input only with Don't Care logic levels.
PROGRAM	Yes	Input	Initiates a configuration sequence when asserted Low.
DONE	Yes	Bidirectional	Indicates that configuration loading is complete, and that the start-up sequence is in progress. The output may be open drain.
INIT	No	Bidirectional (Open-drain)	When Low, indicates that the configuration memory is being cleared. Goes High to indicate the end of initialization. Goes back Low to indicate a CRC error. This pin becomes a user I/O after configuration.
DOUT/BUSY	No	Output	In Slave Parallel mode, BUSY controls the rate at which configuration data can be loaded. It is not needed below 50 MHz. This pin becomes a user I/O after configuration unless the Slave Parallel port is retained. In serial modes, DOUT provides configuration data to downstream devices in a daisy-chain. This pin becomes a user I/O after configuration.

TQ144 Pinouts (XC2S50E and XC2S100E)
(Continued)

Pad Name		Pin	LVDS Async. Output Option	V _{REF} Option
Function	Bank			
I/O ($\overline{CS}$), L5P_YY	1	P112	All	-
I/O ($\overline{WRITE}$), L5N_YY	1	P113	All	-
I/O	1	P114	-	-
I/O, VREF Bank 1	1	P115	-	All
I/O	1	P116	-	-
I/O, L4P_YY	1	P117	All	XC2S100E
I/O, L4N_YY	1	P118	All	-
GND	-	P119	-	-
VCCINT	-	P120	-	-
I/O, L3P_YY	1	P121	All	-
I/O, L3N_YY	1	P122	All	-
I/O, VREF Bank 1	1	P123	-	All
I/O	1	P124	-	-
I/O (DLL), L2P	1	P125	-	-
GCK2, I	1	P126	-	-
GND	-	P127	-	-
VCCO	-	P128	-	-
GCK3, I	0	P129	-	-
VCCINT	-	P130	-	-
I/O (DLL), L2N	0	P131	-	-
I/O, VREF Bank 0	0	P132	-	All
I/O, L1P_YY	0	P133	All	-
I/O, L1N_YY	0	P134	All	-
VCCINT	-	P135	-	-
GND	-	P136	-	-
I/O, L0P_YY	0	P137	All	-
I/O, L0N_YY	0	P138	All	XC2S100E

TQ144 Pinouts (XC2S50E and XC2S100E)
(Continued)

Pad Name		Pin	LVDS Async. Output Option	V _{REF} Option
Function	Bank			
I/O	0	P139	-	-
I/O, VREF Bank 0	0	P140	-	All
I/O	0	P141	-	-
I/O	0	P142	-	-
TCK	-	P143	-	-
VCCO	-	P144	-	-

TQ144 Differential Clock Pins

Clock	Bank	P		N	
		Pin	Name	Pin	Name
GCK0	4	P55	GCK0, I	P56	I/O (DLL), L17P
GCK1	5	P52	GCK1, I	P50	I/O (DLL), L17N
GCK2	1	P126	GCK2, I	P125	I/O (DLL), L2P
GCK3	0	P129	GCK3, I	P131	I/O (DLL), L2N

In the PQ208 package, all VCCO pins must be connected to the same voltage.

PQ208 Pinouts (XC2S50E, XC2S100E, XC2S150E, XC2S200E, XC2S300E)

Pad Name		Pin	LVDS Async. Output Option	V _{REF} Option
Function	Bank			
GND	-	P1	-	-
TMS	-	P2	-	-
I/O	7	P3	-	-
I/O	7	P4	-	XC2S200E, 300E
I/O	7	P5	-	-
I/O, VREF Bank 7, L49P	7	P6	XC2S50E, 150E, 200E, 300E	All
I/O, L49N	7	P7	XC2S50E, 150E, 200E, 300E	-
I/O	7	P8	-	-
I/O	7	P9	-	-
I/O, L48P	7	P10	XC2S50E, 300E	XC2S100E, 150E, 200E, 300E
I/O, L48N	7	P11	XC2S50E, 300E	-
GND	-	P12	-	-
VCCO	-	P13	-	-
VCCINT	-	P14	-	-
I/O, L47P_YY	7	P15	All	-
I/O, L47N_YY	7	P16	All	-
I/O, L46P_YY	7	P17	All	-
I/O, L46N_YY	7	P18	All	-
GND	-	P19	-	-
I/O, VREF Bank 7, L45P	7	P20	XC2S50E, 300E	All
I/O, L45N	7	P21	XC2S50E, 300E	-

PQ208 Pinouts (XC2S50E, XC2S100E, XC2S150E, XC2S200E, XC2S300E)

Pad Name		Pin	LVDS Async. Output Option	V _{REF} Option
Function	Bank			
I/O	7	P22	-	-
I/O, L44P_YY	7	P23	All	-
I/O (IRDY), L44N_YY	7	P24	All	-
GND	-	P25	-	-
VCCO	-	P26	-	-
I/O (TRDY)	6	P27	-	-
VCCINT	-	P28	-	-
I/O	6	P29	-	-
I/O, L43P	6	P30	XC2S50E, 300E	-
I/O, VREF Bank 6, L43N	6	P31	XC2S50E, 300E	All
GND	-	P32	-	-
I/O, L42P_YY	6	P33	All	-
I/O, L42N_YY	6	P34	All	-
I/O, L41P_YY	6	P35	All	-
I/O, L41N_YY	6	P36	All	-
VCCINT	-	P37	-	-
VCCO	-	P38	-	-
GND	-	P39	-	-
I/O, L40P	6	P40	XC2S50E, 300E	-
I/O, L40N	6	P41	XC2S50E, 300E	XC2S100E, 150E, 200E, 300E
I/O	6	P42	-	-
I/O	6	P43	-	-
I/O	6	P44	-	-

FT256 Pinouts (XC2S50E, XC2S100E, XC2S150E, XC2S200E, XC2S300E, XC2S400E)

Pad Name		Pin	LVDS Async. Output Option	V _{REF} Option
Function	Bank			
TMS	-	B1	-	-
I/O	7	D3	-	-
I/O, L83P	7	C2	XC2S100E, 150E	-
I/O, L83N	7	C1	XC2S100E, 150E	XC2S200E, 300E, 400E
I/O, L82P_YY	7	D2	All	-
I/O, L82N_YY	7	D1	All	-
I/O, VREF Bank 7, L81P	7	E3	XC2S50E, 150E, 200E, 300E, 400E	All
I/O, L81N	7	E4	XC2S50E, 150E, 200E, 300E, 400E	-
I/O, L80P	7	E2	XC2S200E, 400E	-
I/O, L80N	7	E1	XC2S200E, 400E	-
I/O, L79P	7	F4	XC2S50E, 300E, 400E	XC2S100E, 150E, 200E, 300E, 400E
I/O, L79N	7	F3	XC2S50E, 300E, 400E	-
I/O, L78P_YY	7	F2	All	-
I/O, L78N_YY	7	F1	All	-
I/O, L77P	7	F5	XC2S100E, 150E	-
I/O, L77N	7	G5	XC2S100E, 150E	-
I/O, L76P_YY	7	G3	All	-
I/O, L76N_YY	7	G4	All	-
I/O, VREF Bank 7, L75P	7	G2	XC2S50E, 300E, 400E	All
I/O, L75N	7	G1	XC2S50E, 300E, 400E	-

**FT256 Pinouts (XC2S50E, XC2S100E, XC2S150E, XC2S200E, XC2S300E, XC2S400E)
(Continued)**

Pad Name		Pin	LVDS Async. Output Option	V _{REF} Option
Function	Bank			
I/O, L74P	7	H4	XC2S100E, 150E, 200E	-
I/O, L74N	7	H3	XC2S100E, 150E, 200E	XC2S400E
I/O, L73P_YY	7	H2	All	-
I/O (IRDY), L73N_YY	7	H1	All	-
I/O (TRDY)	6	J4	-	-
I/O, L72P	6	J2	XC2S100E, 150E, 200E, 400E	XC2S400E
I/O, L72N	6	J3	XC2S100E, 150E, 200E, 400E	-
I/O, L71P	6	J1	XC2S50E, 300E, 400E	-
I/O, VREF Bank 6, L71N	6	K1	XC2S50E, 300E, 400E	All
I/O, L70P_YY	6	K2	All	-
I/O, L70N_YY	6	K3	All	-
I/O, L69P	6	L1	XC2S100E, 150E, 400E	-
I/O, L69N	6	L2	XC2S100E, 150E, 400E	-
I/O, L68P_YY	6	K4	All	-
I/O, L68N_YY	6	K5	All	-
I/O, L67P	6	L3	XC2S50E, 300E, 400E	-
I/O, L67N	6	M2	XC2S50E, 300E, 400E	XC2S100E, 150E, 200E, 300E, 400E
I/O, L66P	6	M1	XC2S150E, 200E, 400E	-
I/O, L66N	6	N1	XC2S150E, 200E, 400E	-

**FT256 Pinouts (XC2S50E, XC2S100E,
XC2S150E, XC2S200E, XC2S300E, XC2S400E)
(Continued)**

Pad Name		Pin	LVDS Async. Output Option	V _{REF} Option
Function	Bank			
I/O (D5), L35N_YY	3	L13	All	-
I/O, L35P_YY	3	K14	All	-
I/O, L34N	3	K15	XC2S100E, 150E, 400E	-
I/O, L34P	3	K16	XC2S100E, 150E, 400E	-
I/O, L33N	3	L12	XC2S50E, 100E, 150E, 200E, 300E ⁽¹⁾	-
I/O, L33P	3	K12	XC2S50E, 100E, 150E, 200E, 300E ⁽¹⁾	-
I/O, VREF Bank 3, L32N	3	K13	XC2S50E, 300E, 400E	All
I/O (D4), L32P	3	J14	XC2S50E, 300E, 400E	-
I/O, L31N	3	J15	XC2S100E, 150E, 200E, 400E	-
I/O, L31P	3	J16	XC2S100E, 150E, 200E, 400E	XC2S400E
I/O (TRDY)	3	J13	-	-
I/O (IRDY), L30N_YY	2	H16	All	-
I/O, L30P_YY	2	G16	All	-
I/O, L29N	2	H14	XC2S100E, 150E, 200E, 400E	XC2S400E
I/O, L29P	2	H15	XC2S100E, 150E, 200E, 400E	-
I/O (D3), L28N	2	G15	XC2S50E, 300E, 400E	-

**FT256 Pinouts (XC2S50E, XC2S100E,
XC2S150E, XC2S200E, XC2S300E, XC2S400E)
(Continued)**

Pad Name		Pin	LVDS Async. Output Option	V _{REF} Option
Function	Bank			
I/O, VREF Bank 2, L28P	2	F16	XC2S50E, 300E, 400E	All
I/O, L27N	2	H13	XC2S50E, 100E, 150E, 200E, 300E ⁽¹⁾	-
I/O, L27P	2	G14	XC2S50E, 100E, 150E, 200E, 300E ⁽²⁾	-
I/O, L26N	2	F15	XC2S100E, 150E, 400E	-
I/O, L26P	2	E16	XC2S100E, 150E, 400E	-
I/O, L25N_YY	2	G13	All	-
I/O (D2), L25P_YY	2	F14	All	-
I/O (D1), L24N	2	E15	XC2S50E, 300E, 400E	-
I/O, L24P	2	D16	XC2S50E, 300E, 400E	XC2S100E, 150E, 200E, 300E, 400E
I/O, L23N	2	F13	XC2S150E, 200E, 400E	-
I/O, L23P	2	E14	XC2S150E, 200E, 400E	-
I/O, L22N	2	D15	XC2S50E, 150E, 200E, 300E, 400E	-
I/O, VREF Bank 2, L22P	2	C16	XC2S50E, 150E, 200E, 300E, 400E	All
I/O, L21N	2	G12	XC2S50E, 100E, 200E, 300E	-
I/O, L21P	2	F12	XC2S50E, 100E, 200E, 300E	-
I/O, L20N	2	E13	XC2S100E, 200E, 300E	-

**FT256 Pinouts (XC2S50E, XC2S100E,
XC2S150E, XC2S200E, XC2S300E, XC2S400E)
(Continued)**

Pad Name		Pin	LVDS Async. Output Option	V _{REF} Option
Function	Bank			
I/O, L20P	2	D14	XC2S100E, 200E, 300E	XC2S200E, 300E, 400E
I/O (DIN, D0), L19N_YY	2	B16	All	-
I/O (DOUT, BUSY), L19P_YY	2	C15	All	-
CCLK	2	A15	-	-
TDO	2	B14	-	-
TDI	-	C13	-	-
I/O ($\overline{\text{CS}}$), L18P_YY	1	A14	All	-
I/O ($\overline{\text{WRITE}}$), L18N_YY	1	A13	All	-
I/O, L17P	1	B13	XC2S50E, 100E, 200E, 300E, 400E	XC2S200E, 300E, 400E
I/O, L17N	1	C12	XC2S50E, 100E, 200E, 300E, 400E	-
I/O, L16P_YY	1	B12	All	-
I/O, L16N_YY	1	A12	All	-
I/O, VREF Bank 1, L15P_YY	1	D12	All	All
I/O, L15N_YY	1	E11	All	-
I/O, L14P	1	D11	XC2S50E, 100E, 150E, 300E	-
I/O, L14N	1	C11	XC2S50E, 100E, 150E, 300E	-
I/O, L13P	1	B11	XC2S50E, 100E, 200E, 300E, 400E	XC2S100E, 150E, 200E, 300E, 400E
I/O, L13N	1	A11	XC2S50E, 100E, 200E, 300E, 400E	-

**FT256 Pinouts (XC2S50E, XC2S100E,
XC2S150E, XC2S200E, XC2S300E, XC2S400E)
(Continued)**

Pad Name		Pin	LVDS Async. Output Option	V _{REF} Option
Function	Bank			
I/O, L12P	1	E10	XC2S50E, 100E, 200E, 300E, 400E	-
I/O, L12N	1	D10	XC2S50E, 100E, 200E, 300E, 400E	-
I/O	1	C10	-	-
I/O, L11P	1	B10	XC2S50E, 200E, 300E, 400E	-
I/O, L11N	1	A10	XC2S50E, 200E, 300E, 400E	-
I/O, VREF Bank 1, L10P	1	D9	XC2S50E, 200E, 300E, 400E	All
I/O, L10N	1	C9	XC2S50E, 200E, 300E, 400E	-
I/O, L9P	1	B9	XC2S50E, 150E, 200E, 400E	-
I/O, L9N	1	A9	XC2S50E, 150E, 200E, 400E	XC2S400E
I/O (DLL), L8P	1	A8	-	-
GCK2, I	1	B8	-	-
GCK3, I	0	C8	-	-
I/O (DLL), L8N	0	D8	-	-
I/O	0	A7	-	XC2S400E
I/O, L7P	0	E7	XC2S50E, 200E, 300E, 400E	-
I/O, VREF Bank 0, L7N	0	D7	XC2S50E, 200E, 300E, 400E	All

FG456 Pinouts (XC2S100E, XC2S150E, XC2S200E, XC2S300E, XC2S400E, XC2S600E)

Pad Name		Pin	LVDS Async. Output Option	V _{REF} Option	Device-Specific Pinouts: XC2S					
Function	Bank				100E	150E	200E	300E	400E	600E
TMS	-	E4	-	-	TMS	TMS	TMS	TMS	TMS	TMS
I/O	7	D3	XC2S150E	-	I/O	I/O, L113P_Y	I/O	I/O	I/O	I/O
I/O	7	C2	-	-	-	-	-	I/O	I/O	I/O
I/O	7	C1	XC2S150E	-	-	I/O, L113N_Y	I/O	I/O	I/O	I/O
I/O, L#P_Y	7	D2	XC2S150E, 200E, 300E, 400E	-	-	I/O, L112P_Y	I/O, L119P_Y	I/O, L119P_Y	I/O, L119P_Y	I/O, L119P
I/O, L#N_Y	7	D1	XC2S150E, 200E, 300E, 400E	-	I/O	I/O, L112N_Y	I/O, L119N_Y	I/O, L119N_Y	I/O, L119N_Y	I/O, L119N
I/O, L#P_Y	7	E2	XC2S100E, 200E, 300E, 600E	XC2S200E, 300E, 400E, 600E	I/O, L85P_Y	I/O, L111P	I/O, VREF Bank 7, L118P_Y	I/O, VREF Bank 7, L118P_Y	I/O, VREF Bank 7, L118P	I/O, VREF Bank 7, L118P_Y
I/O, L#N_Y	7	E3	XC2S100E, 200E, 300E, 600E	-	I/O, L85N_Y	I/O, L111N	I/O, L118N_Y	I/O, L118N_Y	I/O, L118N	I/O, L118N_Y
I/O	7	E1	-	-	-	-	-	I/O	I/O	I/O
I/O	7	F5	-	-	-	I/O	I/O	I/O	I/O	I/O
I/O, L#P_Y	7	F4	XC2S100E, 200E, 300E, 600E	-	I/O, L84P_Y	I/O, L110P	I/O, L117P_Y	I/O, L117P_Y	I/O, L117P	I/O, L117P_Y
I/O, L#N_Y	7	F3	XC2S100E, 200E, 300E, 600E	-	I/O, L84N_Y	I/O, L110N	I/O, L117N_Y	I/O, L117N_Y	I/O, L117N	I/O, L117N_Y
I/O, VREF Bank 7, L#P_Y	7	F2	XC2S150E, 200E, 300E, 400E, 600E	All	I/O, VREF Bank 7, L83P	I/O, VREF Bank 7, L109P_Y	I/O, VREF Bank 7, L116P_Y	I/O, VREF Bank 7, L116P_Y	I/O, VREF Bank 7, L116P_Y	I/O, VREF Bank 7, L116P_Y
I/O, L#N_Y	7	F1	XC2S150E, 200E, 300E, 400E, 600E	-	I/O, L83N	I/O, L109N_Y	I/O, L116N_Y	I/O, L116N_Y	I/O, L116N_Y	I/O, L116N_Y
I/O	7	G5	-	-	-	I/O	I/O	I/O	I/O	I/O
I/O, L#P_Y	7	G4	XC2S150E, 200E, 300E, 400E	-	-	I/O, L108P_Y	I/O, L115P_Y	I/O, L115P_Y	I/O, L115P_Y	I/O, L115P
I/O, L#N_Y	7	G3	XC2S150E, 200E, 300E, 400E	-	I/O	I/O, L108N_Y	I/O, L115N_Y	I/O, L115N_Y	I/O, L115N_Y	I/O, L115N
I/O, L#P_Y	7	G2	XC2S100E, 150E, 300E, 600E	XC2S600E	I/O, L82P_Y	I/O, L107P_Y	I/O, L114P	I/O, L114P_Y	I/O, L114P	I/O, VREF Bank 7, L114P_Y
I/O, L#N_Y	7	G1	XC2S100E, 150E, 300E, 600E	-	I/O, L82N_Y	I/O, L107N_Y	I/O, L114N	I/O, L114N_Y	I/O, L114N	I/O, L114N_Y

FG456 Pinouts (XC2S100E, XC2S150E, XC2S200E, XC2S300E, XC2S400E, XC2S600E)

Pad Name		Pin	LVDS Async. Output Option	V _{REF} Option	Device-Specific Pinouts: XC2S					
Function	Bank				100E	150E	200E	300E	400E	600E
I/O, L#P_YY	7	L5	All	-	I/O, L75P_YY	I/O, L99P_YY	I/O, L105P_YY	I/O, L105P_YY	I/O, L105P_YY	I/O, L105P_YY
I/O (IRDY), L#N_YY	7	L6	All	-	I/O (IRDY), L75N_YY	I/O (IRDY), L99N_YY	I/O (IRDY), L105N_YY	I/O (IRDY), L105N_YY	I/O (IRDY), L105N_YY	I/O (IRDY), L105N_YY
I/O (TRDY)	6	M1	-	-	I/O (TRDY)	I/O (TRDY)	I/O (TRDY)	I/O (TRDY)	I/O (TRDY)	I/O (TRDY)
I/O	6	M2	-	-	-	-	-	I/O	I/O	I/O
I/O, L#P_Y	6	M3	XC2S200E, 300E, 600E	-	-	I/O	I/O, L104P_Y	I/O, L104P_Y	I/O, L104P	I/O, L104P_Y
I/O, L#N_Y	6	M4	XC2S100E, 150E, 200E, 300E, 600E	XC2S400E, 600E	I/O, L74P_Y	I/O, L98P_Y	I/O, L104N_Y	I/O, L104N_Y	I/O, VREF Bank 6, L104N	I/O, VREF Bank 6, L104N_Y
I/O, L#P_Y	6	M5	XC2S100E, 150E, 300E, 400E	-	I/O, L74N_Y	I/O, L98N_Y	I/O, L103P	I/O, L103P_Y	I/O, L103P_Y	I/O, L103P
I/O, L#N_Y	6	M6	XC2S300E, 400E	-	-	-	I/O, L103N	I/O, L103N_Y	I/O, L103N_Y	I/O, L103N
I/O	6	N1	-	-	-	-	-	I/O	I/O	I/O
I/O	6	N2	-	-	I/O, L73P	I/O, L97P	I/O	I/O	I/O	I/O
I/O, VREF Bank 6, L#P	6	N3	XC2S200E, 400E	All	I/O, VREF Bank 6, L73N	I/O, VREF Bank 6, L97N	I/O, VREF Bank 6, L102P_Y	I/O, VREF Bank 6, L102P	I/O, VREF Bank 6, L102P_Y	I/O, VREF Bank 6, L102P
I/O, L#N	6	N4	XC2S100E, 150E, 200E, 400E	-	I/O, L72P_Y	I/O, L96P_Y	I/O, L102N_Y	I/O, L102N	I/O, L102N_Y	I/O, L102N
I/O, L#P_Y	6	N5	XC2S100E, 150E, 300E, 600E	-	I/O, L72N_Y	I/O, L96N_Y	I/O, L101P	I/O, L101P_Y	I/O, L101P	I/O, L101P_Y
I/O, L#N_Y	6	N6	XC2S300E, 600E	-	-	-	I/O, L101N	I/O, L101N_Y	I/O, L101N	I/O, L101N_Y
I/O, L#P_Y	6	P1	XC2S150E, 200E, 300E, 600E	-	-	I/O, L95P_Y	I/O, L100P_Y	I/O, L100P_Y	I/O, L100P	I/O, L100P_Y
I/O, L#N_Y	6	P2	XC2S100E, 150E, 200E, 300E, 600E	-	I/O, L71P_Y	I/O, L95N_Y	I/O, L100N_Y	I/O, L100N_Y	I/O, L100N	I/O, L100N_Y
I/O	6	R1	XC2S100E, 150E	-	I/O, L71N_Y	I/O, L94P_Y	I/O	I/O	I/O	I/O
I/O, L#P_Y	6	P3	XC2S150E, 200E, 300E, 400E, 600E	-	-	I/O, L94N_Y	I/O, L99P_Y	I/O, L99P_Y	I/O, L99P_Y	I/O, L99P_Y
I/O, L#N_Y	6	P4	XC2S200E, 300E, 400E, 600E	-	-	-	I/O, L99N_Y	I/O, L99N_Y	I/O, L99N_Y	I/O, L99N_Y
I/O, L#P_YY	6	P5	All	-	I/O, L70P_YY	I/O, L93P_YY	I/O, L98P_YY	I/O, L98P_YY	I/O, L98P_YY	I/O, L98P_YY
I/O, L#N_YY	6	P6	All	-	I/O, L70N_YY	I/O, L93N_YY	I/O, L98N_YY	I/O, L98N_YY	I/O, L98N_YY	I/O, L98N_YY

FG456 Pinouts (XC2S100E, XC2S150E, XC2S200E, XC2S300E, XC2S400E, XC2S600E)

Pad Name		Pin	LVDS Async. Output Option	V _{REF} Option	Device-Specific Pinouts: XC2S					
Function	Bank				100E	150E	200E	300E	400E	600E
I/O, L#P_Y	6	R2	XC2S300E, 400E, 600E	-	I/O, L69P	I/O, L92P	I/O, L97P	I/O, L97P_Y	I/O, L97P_Y	I/O, L97P_Y
I/O, VREF Bank 6, L#N_Y	6	R3	XC2S300E, 400E, 600E	All	I/O, VREF Bank 6, L69N	I/O, VREF Bank 6, L92N	I/O, VREF Bank 6, L97N	I/O, VREF Bank 6, L97N_Y	I/O, VREF Bank 6, L97N_Y	I/O, VREF Bank 6, L97N_Y
I/O	6	R4	-	-	-	-	-	I/O	I/O	I/O
I/O	6	R5	-	-	I/O	I/O	I/O	I/O	I/O	I/O
I/O, L#P	6	T2	XC2S200E, 400E, 600E	XC2S600E	I/O, L68P	I/O, L91P	I/O, L96P_Y	I/O, L96P	I/O, L96P_Y	I/O, VREF Bank 6, L96P_Y
I/O, L#N	6	T3	XC2S200E, 400E, 600E	-	I/O, L68N	I/O, L91N	I/O, L96N_Y	I/O, L96N	I/O, L96N_Y	I/O, L96N_Y
I/O, L#P_Y	6	T4	XC2S150E, 300E, 400E	-	-	I/O, L90P_Y	I/O, L95P	I/O, L95P_Y	I/O, L95P_Y	I/O, L95P
I/O, L#N_Y	6	T5	XC2S150E, 300E, 400E	-	-	I/O, L90N_Y	I/O, L95N	I/O, L95N_Y	I/O, L95N_Y	I/O, L95N
I/O, L#P_Y	6	T1	XC2S150E, 200E, 300E, 400E, 600E	-	I/O, L67P	I/O, L89P_Y	I/O, L94P_Y	I/O, L94P_Y	I/O, L94P_Y	I/O, L94P_Y
I/O, VREF Bank 6, L#N_Y	6	U1	XC2S150E, 200E, 300E, 400E, 600E	All	I/O, VREF Bank 6, L67N	I/O, VREF Bank 6, L89N_Y	I/O, VREF Bank 6, L94N_Y	I/O, VREF Bank 6, L94N_Y	I/O, VREF Bank 6, L94N_Y	I/O, VREF Bank 6, L94N_Y
I/O	6	U2	XC2S100E	-	I/O, L66P_Y	I/O	I/O	I/O	I/O	I/O
I/O, L#P_Y	6	U3	XC2S100E, 150E, 200E, 300E, 400E, 600E	-	I/O, L66N_Y	I/O, L88P_Y	I/O, L93P_Y	I/O, L93P_Y	I/O, L93P_Y	I/O, L93P_Y
I/O, L#N_Y	6	U4	XC2S150E, 200E, 300E, 400E, 600E	-	-	I/O, L88N_Y	I/O, L93N_Y	I/O, L93N_Y	I/O, L93N_Y	I/O, L93N_Y
I/O	6	V1	-	-	-	-	-	I/O	I/O	I/O
I/O, L#P_Y	6	W1	XC2S100E, 200E, 300E, 600E	-	I/O, L65P_Y	I/O, L87P	I/O, L92P_Y	I/O, L92P_Y	I/O, L92P	I/O, L92P_Y
I/O, L#N_Y	6	V2	XC2S100E, 200E, 300E, 600E	XC2S200E, 300E, 400E, 600E	I/O, L65N_Y	I/O, L87N	I/O, VREF Bank 6, L92N_Y	I/O, VREF Bank 6, L92N_Y	I/O, VREF Bank 6, L92N	I/O, VREF Bank 6, L92N_Y
I/O	6	W2	-	-	I/O	I/O	I/O	I/O	I/O	I/O
I/O, L#P_Y	6	V3	XC2S200E, 300E, 400E	-	-	I/O, L86P	I/O, L91P_Y	I/O, L91P_Y	I/O, L91P_Y	I/O, L91P
I/O, L#N_Y	6	V4	XC2S200E, 300E, 400E	-	-	I/O, L86N	I/O, L91N_Y	I/O, L91N_Y	I/O, L91N_Y	I/O, L91N
I/O	6	Y1	-	-	-	-	-	I/O	I/O	I/O
I/O, L#P_YY	6	Y2	All	-	I/O, L64P_YY	I/O, L85P_YY	I/O, L90P_YY	I/O, L90P_YY	I/O, L90P_YY	I/O, L90P_YY
I/O, L#N_YY	6	W3	All	-	I/O, L64N_YY	I/O, L85N_YY	I/O, L90N_YY	I/O, L90N_YY	I/O, L90N_YY	I/O, L90N_YY
M1	-	U5	-	-	M1	M1	M1	M1	M1	M1

Additional FG456 Package Pins (Continued)

VCCO Bank 1 Pins								
F15	F16	G13	G14	-	-	-	-	-
VCCO Bank 2 Pins								
G17	H17	J16	K16	-	-	-	-	-
VCCO Bank 3 Pins								
N16	P16	R17	T17	-	-	-	-	-
VCCO Bank 4 Pins								
T13	T14	U15	U16	-	-	-	-	-
VCCO Bank 5 Pins								
T9	T10	U7	U8	-	-	-	-	-
VCCO Bank 6 Pins								
N7	P7	R6	T6	-	-	-	-	-
VCCO Bank 7 Pins								
G6	H6	J7	K7	-	-	-	-	-
GND Pins								
A1	A2 ⁽²⁾	A22	B1 ⁽²⁾	B2	B21	C3	C20	G11
G12	J9	J10	J11	J12	J13	J14	K9	K10
K11	K12	K13	K14	L7	L9	L10	L11	L12
L13	L14	L16	M7	M9	M10	M11	M12	M13
M14	M16	N9	N10	N11	N12	N13	N14	P9
P10	P11	P12	P13	P14	T11	T12	Y20	Y3
Y4 ⁽²⁾	AA2	AA4 ⁽²⁾	AA21	AA22 ⁽²⁾	AB1	AB22	-	-
Not Connected Pins								
A2 ⁽²⁾	B1 ⁽²⁾	D4 ⁽¹⁾	D19 ⁽¹⁾	W4 ⁽¹⁾	W19 ⁽¹⁾	Y4 ⁽²⁾	AA4 ⁽²⁾	AA22 ⁽²⁾

Notes:

- VCCINT connections in XC2S400E and XC2S600E. No Connects (no internal connection) in XC2S100E, XC2S150E, XC2S200E, and XC2S300E.
- GND connections in XC2S400E and XC2S600E. No Connects (no internal connection) in XC2S100E, XC2S150E, XC2S200E, and XC2S300E.

FG676 Pinouts (XC2S400E, XC2S600E)

Pad Name		Pin	LVDS Async. Output Option	VREF Option	Device-Specific Pinouts	
Function	Bank				XC2S400E	XC2S600E
TMS	-	B1	-	-	TMS	TMS
I/O	7	D3	-	-	I/O	I/O
I/O, L204P	7	C2	-	-	-	I/O, L204P
I/O, L204N	7	C1	-	-	-	I/O, L204N
I/O, L203P	7	D2	XC2S600E	-	-	I/O, L203P_Y
I/O, L203N	7	D1	XC2S600E	-	I/O	I/O, L203N_Y
I/O, L202P_YY	7	E2	All	-	I/O, L202P_YY	I/O, L202P_YY
I/O, L202N_YY	7	E1	All	-	I/O, L202N_YY	I/O, L202N_YY

FG676 Pinouts (XC2S400E, XC2S600E) (Continued)

Pad Name		Pin	LVDS Async. Output Option	VREF Option	Device-Specific Pinouts	
Function	Bank				XC2S400E	XC2S600E
I/O, L201P	7	E4	XC2S400E	-	I/O, L201P_Y	I/O, L201P
I/O, L201N	7	F5	XC2S400E	-	I/O, L201N_Y	I/O, L201N
I/O, VREF Bank 7, L200P	7	F4	XC2S600E	All	I/O, VREF Bank 7, L200P	I/O, VREF Bank 7, L200P_Y
I/O, L200N	7	F3	XC2S600E	-	I/O, L200N	I/O, L200N_Y
I/O, L199P	7	F2	XC2S600E	-	-	I/O, L199P_Y
I/O, L199N	7	F1	XC2S600E	-	I/O	I/O, L199N_Y
I/O, L198P	7	G6	XC2S400E	-	I/O, L198P_Y	I/O, L198P
I/O, L198N	7	G5	XC2S400E	-	I/O, L198N_Y	I/O, L198N
I/O, L197P	7	G4	XC2S600E	-	I/O, L197P	I/O, L197P_Y
I/O, L197N	7	G3	XC2S600E	-	I/O, L197N	I/O, L197N_Y
I/O, VREF Bank 7, L196P_YY	7	G2	All	All	I/O, VREF Bank 7, L196P_YY	I/O, VREF Bank 7, L196P_YY
I/O, L196N_YY	7	G1	All	-	I/O, L196N_YY	I/O, L196N_YY
I/O	7	H7	-	-	I/O	I/O
I/O, L195P_YY	7	H6	All	-	I/O, L195P_YY	I/O, L195P_YY
I/O, L195N_YY	7	H5	All	-	I/O, L195N_YY	I/O, L195N_YY
I/O	7	J8	-	-	-	I/O
I/O, L194P	7	H2	XC2S400E	-	I/O, L194P_Y	I/O, L194P
I/O, L194N	7	H1	XC2S400E	-	I/O, L194N_Y	I/O, L194N
I/O, L193P	7	J7	XC2S600E	XC2S600E	I/O	I/O, VREF Bank 7, L193P_Y
I/O, L193N	7	J6	XC2S600E	-	-	I/O, L193N_Y
I/O	7	J5	-	-	I/O	I/O
I/O, L192P_YY	7	J4	All	-	I/O, L192P_YY	I/O, L192P_YY
I/O, L192N_YY	7	J3	All	-	I/O, L192N_YY	I/O, L192N_YY
I/O	7	K5	-	-	I/O	I/O
I/O, VREF Bank 7, L191P_YY	7	J2	All	All	I/O, VREF Bank 7, L191P_YY	I/O, VREF Bank 7, L191P_YY
I/O, L191N_YY	7	J1	All	-	I/O, L191N_YY	I/O, L191N_YY
I/O, L190P_YY	7	K8	All	-	I/O, L190P_YY	I/O, L190P_YY
I/O, L190N_YY	7	K7	All	-	I/O, L190N_YY	I/O, L190N_YY
I/O	7	K4	-	-	-	I/O
I/O, L189P_YY	7	K3	All	-	I/O, L189P_YY	I/O, L189P_YY
I/O, L189N_YY	7	K2	All	-	I/O, L189N_YY	I/O, L189N_YY
I/O	7	K1	-	-	-	I/O

FG676 Pinouts (XC2S400E, XC2S600E) (Continued)

Pad Name		Pin	LVDS Async. Output Option	VREF Option	Device-Specific Pinouts	
Function	Bank				XC2S400E	XC2S600E
I/O, VREF Bank 6, L176N	6	P9	XC2S600E	All	I/O, VREF Bank 6, L176N	I/O, VREF Bank 6, L176N_Y
I/O, L175P	6	R1	XC2S400E	-	I/O, L175P_Y	I/O, L175P
I/O, L175N	6	R2	XC2S400E	-	I/O, L175N_Y	I/O, L175N
I/O	6	R4	-	-	-	I/O
I/O, L174P_YY	6	R5	All	-	I/O, L174P_YY	I/O, L174P_YY
I/O, L174N_YY	6	R6	All	-	I/O, L174N_YY	I/O, L174N_YY
I/O	6	R7	-	-	-	I/O
I/O, L173P_YY	6	R8	All	-	I/O, L173P_YY	I/O, L173P_YY
I/O, VREF Bank 6, L173N_YY	6	R9	All	All	I/O, VREF Bank 6, L173N_YY	I/O, VREF Bank 6, L173N_YY
I/O, L172P	6	T1	XC2S600E	-	I/O, L172P	I/O, L172P_Y
I/O, L172N	6	T2	XC2S600E	-	I/O, L172N	I/O, L172N_Y
I/O	6	T3	-	-	-	I/O
I/O, L171P	6	T5	XC2S600E	-	I/O, L171P	I/O, L171P_Y
I/O, L171N	6	T6	XC2S600E	-	I/O, L171N	I/O, L171N_Y
I/O	6	U1	-	-	-	I/O
I/O, L170P	6	T7	XC2S600E	-	I/O, L170P	I/O, L170P_Y
I/O, L170N	6	T8	XC2S600E	-	I/O, L170N	I/O, L170N_Y
I/O, L169P	6	U2	XC2S400E	-	I/O, L169P_Y	I/O, L169P
I/O, L169N	6	U3	XC2S400E	-	I/O, L169N_Y	I/O, L169N
I/O	6	U7	-	-	-	I/O
I/O, L168P	6	U4	XC2S600E	-	-	I/O, L168P_Y
I/O, L168N	6	U5	XC2S600E	-	I/O	I/O, L168N_Y
I/O	6	U8	-	-	I/O	I/O
I/O, L167P_YY	6	V1	All	-	I/O, L167P_YY	I/O, L167P_YY
I/O, L167N_YY	6	V2	All	-	I/O, L167N_YY	I/O, L167N_YY
I/O	6	V3	-	-	I/O	I/O
I/O, VREF Bank 6, L166P_YY	6	V4	All	All	I/O, VREF Bank 6, L166P_YY	I/O, VREF Bank 6, L166P_YY
I/O, L166N_YY	6	V5	All	-	I/O, L166N_YY	I/O, L166N_YY
I/O, L165P_YY	6	V6	All	-	I/O, L165P_YY	I/O, L165P_YY
I/O, L165N_YY	6	V7	All	-	I/O, L165N_YY	I/O, L165N_YY
I/O	6	V8	-	-	-	I/O
I/O, L164P	6	W1	XC2S600E	-	I/O, L164P	I/O, L164P_Y

FG676 Pinouts (XC2S400E, XC2S600E) (Continued)

Pad Name		Pin	LVDS Async. Output Option	VREF Option	Device-Specific Pinouts	
Function	Bank				XC2S400E	XC2S600E
I/O, L51N	2	D24	-	-	-	I/O, L51N
I/O, L51P	2	C25	-	-	-	I/O, L51P
I/O (DIN, D0), L50N_YY	2	C26	All	-	I/O (DIN, D0), L50N_YY	I/O (DIN, D0), L50N_YY
I/O (DOUT, BUSY), L50P_YY	2	B26	All	-	I/O (DOUT, BUSY), L50P_YY	I/O (DOUT, BUSY), L50P_YY
CCLK	2	A25	-	-	CCLK	CCLK
TDO	2	C23	-	-	TDO	TDO
TDI	-	D22	-	-	TDI	TDI
I/O ($\overline{CS}$), L49P_YY	1	B24	All	-	I/O ($\overline{CS}$), L49P_YY	I/O ($\overline{CS}$), L49P_YY
I/O ($\overline{WRITE}$), L49N_YY	1	A24	All	-	I/O ($\overline{WRITE}$), L49N_YY	I/O ($\overline{WRITE}$), L49N_YY
I/O, L48P	1	B23	-	-	I/O	I/O, L48P
I/O, L48N	1	A23	-	-	-	I/O, L48N
I/O, L47P	1	B22	XC2S400E	-	I/O, L47P_Y	I/O, L47P
I/O, L47N	1	A22	XC2S400E	-	I/O, L47N_Y	I/O, L47N
I/O, L46P_YY	1	D21	All	-	I/O, L46P_YY	I/O, L46P_YY
I/O, L46N_YY	1	C21	All	-	I/O, L46N_YY	I/O, L46N_YY
I/O, VREF Bank 1, L45P_YY	1	B21	All	All	I/O, VREF Bank 1, L45P_YY	I/O, VREF Bank 1, L45P_YY
I/O, L45N_YY	1	A21	All	-	I/O, L45N_YY	I/O, L45N_YY
I/O, L44P	1	F20	XC2S600E	-	-	I/O, L44P_Y
I/O, L44N	1	E20	XC2S600E	-	I/O	I/O, L44N_Y
I/O, L43P_YY	1	D20	All	-	I/O, L43P_YY	I/O, L43P_YY
I/O, L43N_YY	1	C20	All	-	I/O, L43N_YY	I/O, L43N_YY
I/O, L42P_YY	1	B20	All	-	I/O, L42P_YY	I/O, L42P_YY
I/O, L42N_YY	1	A20	All	-	I/O, L42N_YY	I/O, L42N_YY
I/O, VREF Bank 1, L41P_YY	1	G19	All	All	I/O, VREF Bank 1, L41P_YY	I/O, VREF Bank 1, L41P_YY
I/O, L41N_YY	1	F19	All	-	I/O, L41N_YY	I/O, L41N_YY
I/O	1	E19	-	-	-	I/O
I/O, L40P_YY	1	B19	All	-	I/O, L40P_YY	I/O, L40P_YY
I/O, L40N_YY	1	A19	All	-	I/O, L40N_YY	I/O, L40N_YY
I/O	1	H18	-	-	I/O	I/O
I/O, L39P	1	G18	XC2S600E	-	I/O, L39P	I/O, L39P_Y